

Fang cheng Electronics(Dong guan) Co,LTD
SPECIFICATION FOR APPROVAL

CUSTOMER:
Part Number : SMD POWER CHOKE
CUSTOMER Number:
CUSTOMER Part :
Fangcheng part : FCRH7045-102M-L-S
DATE: 2021-1-11
REV: 01



made in fangcheng:

CUSTOMER APPROD:

| prepad | checd | Approd | prepad | checd | Approd |
|--------|-------|--------|--------|-------|--------|
| | | | | | |

THE INFORMATION CONTAINED IN THIS DOCUMENT IS OF A PROPRIETARY NATURE AND IS INTENDED TO BE KEPT CONFIDENTIAL BETWEEN THE SENDER AND THE INTENDED RECIPIENT. IT MAY NOT BE REPRODUCED OR USED WITHOUT EXPRESS WRITTEN PERMISSION OF FC TECHNOLOGIES, OR FC



FANGCHENG ELECTRON
FANGCHENG ELECTRONICS (DONGGUAN) CO., LTD.

Fangcheng Electronics (Dongguan) Co., Ltd.

Tel: +86 0769-82988010
Fax: +86 0769-82988065
E-mail: yhl@fangchengcoils.com
URL: www.fangchengcoils.com
Address: Building 3, Jinmei Technology Park, No.16 Huanchang West Road, Changping Town, Dongguan City



Fangcheng Electronics (China-Taiwan) Office
Address: No. 31, MRT Road, Zhonghe District, New Taipei City
Tel: +8869-983491379

Notice of Use

For the parameters not prescribed in the *Specification for Approval*, please refer to the following standards or the relative industry standards.

1. Product in packing storage condition : temperature 540, RH70%.
2. A storage of –FC- Electronic products for longer than 12 months is not recommended, Within other effects, the terminals may suffer degradation, resulting in bad solderability. Therefore, all products shall be used within the period of 12 months based on the day of shipment.
3. Do not keep products in unsuitable storage conditions, such as areas susceptible to high temperatures, high humidity, dust or corrosion.
- 4 Always handle products with care.
- 5 Don't touch electrodes directly with bare hands as oil secretions may inhibit soldering. Always ensure optimum conditions for soldering.
- 6 When this product will be used on a similar or new project to the original one, sometimes it might be unable to satisfy the specifications due to different condition of usage.
- 7 This inductor itself does not have any protective function in abnormal condition, such as overload, short-circuit, open-circuit conditions, etc. Therefore, it shall be confirmed that there is no risk of smoke, fire, dielectric withstand voltage, insulation resistance, etc., or use in abnormal conditions protective devices or protection circuit in the end product.
- 8 Hi-Pot test with higher voltage than spec value will damage insulating material and shorten its life.

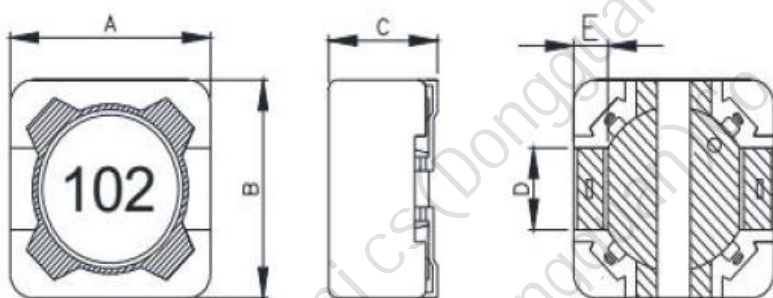
IPC 020D Joint Industry standard

IEC1007 《Transformer and inductors for use in electronic and telecommunication equipment—Measuring methods and test procedures》

(ROHS or other environmental request)

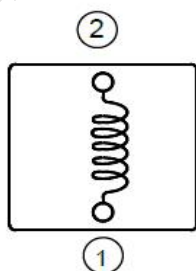
1. Appearance and Dimensions(mm)

| | | |
|-------------------|----------------|----------------------|
| Prepad Zhangli | Checd Tylee | Approd David-yuan |
|-------------------|----------------|----------------------|

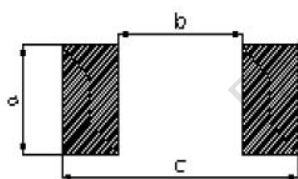


| 尺寸 | A | B | C | D | E |
|---------|---------------|---------------|---------|---------------|---------------|
| 单位 (mm) | 7.5 ± 0.3 | 7.5 ± 0.3 | 4.5 max | 2.7 ± 0.2 | 1.0 ± 0.2 |

2. Schematic :



3. Reference LandPattern (mm)



推荐安装焊盘 (mm)

| | |
|---|-------------|
| a | 2.11 mm REF |
| b | 5.0 mm REF |
| c | 7.29 mm REF |

4. Electrical Characteristics :

| | | |
|-------------------|----------------|----------------------|
| Prepad Zhangli | Checd Tylee | Approd David-yuan |
|-------------------|----------------|----------------------|

Customer: Part Number: FCRH7045-102M-L-S
 made : 方成电子 (东莞) 有限公司 Page: 5 ----- 8

| Part No. | Inductance (mH) | D.C.R. (Ω) | Saturation current (mA) | Temperature rise current (mA) |
|-------------------|-----------------|---------------------|-------------------------|-------------------------------|
| FCRH7045-102M-L-S | $\pm 20\%$ | MAX | MAX | MAX |
| | 1.0 | 4.5 Ω | 300 | 300 |

- (1).Rated Current: Base on temp.rise & $\Delta L/L0A \leq 30\%$ Max and $\Delta T = 40^{\circ}C$ Typ
- (2).Operating Temperature: $-40^{\circ}C$ up to $+125^{\circ}C$
- (3).Storage Temperature: $-20^{\circ}C$ up to $+40^{\circ}C$, 75% RH max.
- (4)All data is tested based on 25ambient temperature.
- (5)Operatingtemperature-40+125(Including coil's temperature rise)

Special remindCircuit design, component placement, PCB size andthickness,cooling systemand etc. allwillaffectthe producttemperature.Please verify the product temperature in the final application.

6. Reliability and test condition:

| Test item | test condition | Remark |
|-------------------|----------------|----------------------|
| Prepad Zhangli | Checd Tylee | Approd David-yuan |

| Test item | test condition | Remark |
|--|---------------------------------|--------|
| Cold Operating Test | GB2423.1 Ad | |
| Heat Operating Test | GB2423.2 Bd | |
| Cold Storage Test | GB2423.1 Ab | |
| Heat Storage Test | GB2423.2 Bb | |
| Steady Damp Heat Test | GB2423.3 Cb | |
| Circular Damp Heat Test | GB2423.4 Db | |
| Temperature Cycling Test | GB2423.22 Nb | |
| Temperature Shock Test | GB2423.22 Na | |
| Vibration Test | GB2423.10~15 Fc, Fdb | |
| Mechanical Shock Test (Bump) | GB2423.5 Eb | |
| Free Fall Test | GB2423.8 Ed | |
| Solderability | GJB360A-96 | |
| High Temperature Step Stress Test | Enhancement Test Specifications | |
| Low Temperature Step Stress Test | | |
| High-speed Thermal Cycling | | |
| Limit Vibration | | |
| Composite Stress | | |
| Highly-Accelerated Temperature and Humidity Stress Test (HAST) (| | |

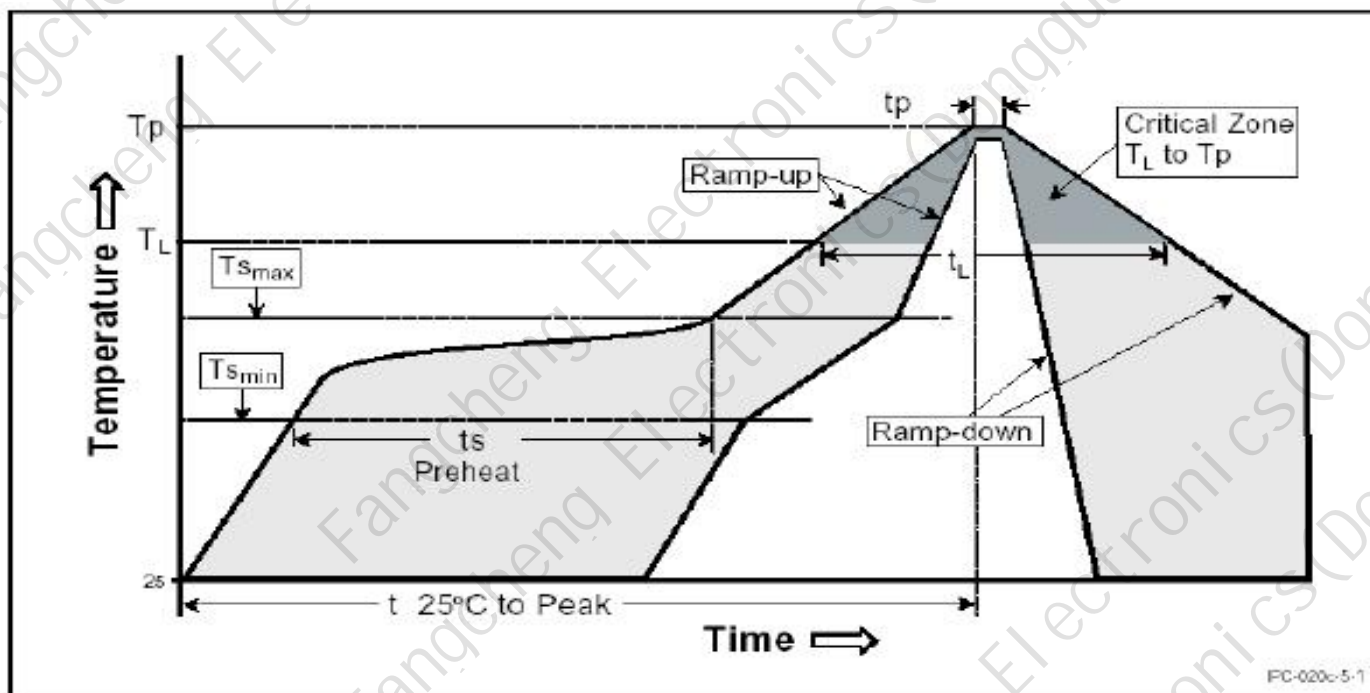
7. Soldering Specification:

| | | |
|-------------------|-----------------|----------------------|
| Prepad Zhangli | Checkd Tylee | Approd David-yuan |
|-------------------|-----------------|----------------------|

7. 1 Reflow Profile for SMT Components.

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|---|------------------------------------|------------------------------------|
| Average Ramp-Up Rate ($T_{S_{max}}$ to T_p) | 3 °C/second max. | 3° C/second max. |
| Preheat - Temperature Min ($T_{S_{min}}$) - Temperature Max ($T_{S_{max}}$) - Time ($t_{S_{min}}$ to $t_{S_{max}}$) | 100 °C 150 °C 60-120 seconds | 150 °C 200 °C 60-180 seconds |
| Time maintained above: - Temperature (T_L) - Time (t_L) | 183 °C 60-150 seconds | 217 °C 60-150 seconds |
| Peak/Classification Temperature (T_p) | See Table 4.1 | See Table 4.2 |
| Time within 5 °C of actual Peak Temperature (t_p) | 10-30 seconds | 20-40 seconds |
| Ramp-Down Rate | 6 °C/second max. | 6 °C/second max. |
| Time 25 °C to Peak Temperature | 6 minutes max. | 8 minutes max. |

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

7. 2 Classification of Peak Package Body Temperature (T_P)

| Package Thickness | Volume mm ³ <350 | Volume mm ³ 350 - 2000 | Volume mm ³ >2000 |
|-------------------|-----------------------------|-----------------------------------|------------------------------|
| <1.6 mm | 260 +0 °C * | 260 +0 °C * | 260 +0 °C * |
| 1.6 mm - 2.5 mm | 260 +0 °C * | 250 +0 °C * | 245 +0 °C * |
| ≥2.5 mm | 250 +0 °C * | 245 +0 °C * | 245 +0 °C * |

* Tolerance: The device manufacturer/supplier shall assure process compatibility up to and including the stated classification temperature (this means Peak reflow temperature +0 °C. For example 260 °C+0°C) at the rated MSL level.

8. Reel Dimensions (mm)

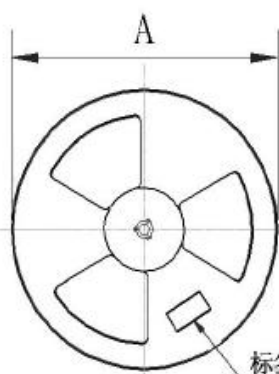
| | | |
|-------------------|-----------------|----------------------|
| Prepad Zhangli | Checkd Tylee | Approd David-yuan |
|-------------------|-----------------|----------------------|

Customer:

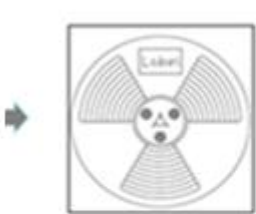
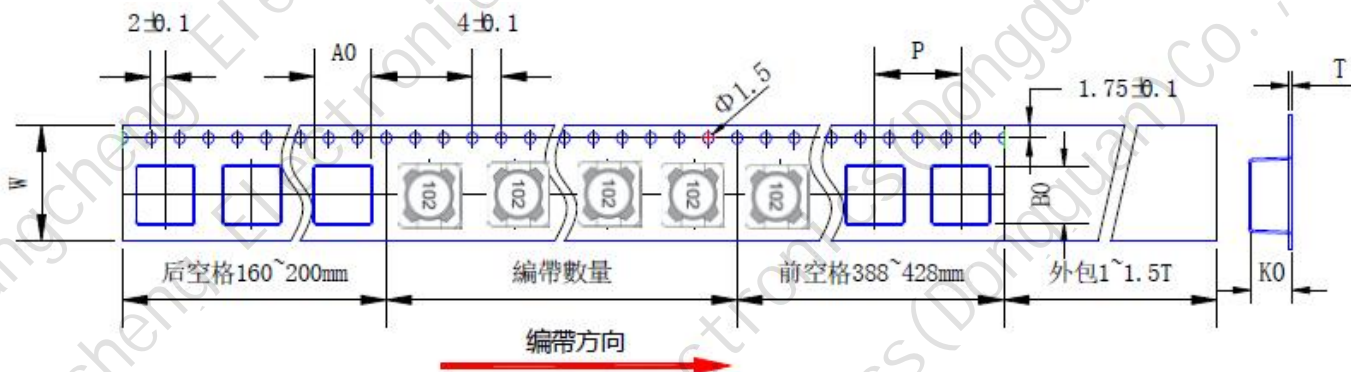
made : 方成电子 (东莞) 有限公司

Part Number: FCRH7045-102M-L-S

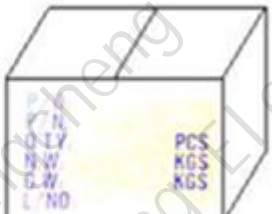
Page: 8 ----- 8



| 包装盘尺寸 (mm) | | |
|------------|------|-----|
| A | B | C |
| 330 | 16.5 | 100 |



1000 PCS



9000 PCS

II, AQL=0.4; L0A, L30DC, S-4, AQL=0.15.
 The inspection must be performed per GB/T2828.1-2003, with its examination level: Appearance and dimensions, II, AQL=0.4; L0A and L30DC, S-4, AQL: 0.15;

| | | |
|-------------------|----------------|----------------------|
| Prepad Zhangli | Checd Tylee | Approd David-yuan |
|-------------------|----------------|----------------------|